

Title (en)

METHOD FOR METALLIZING A NON-METALLIC SUBSTRATE AND PRE-TREATMENT COMPOSITION

Title (de)

VERFAHREN ZUR METALLISIERUNG EINES NICHTMETALLISCHEN SUBSTRATS UND VORBEHANDLUNGSZUSAMMENSETZUNG

Title (fr)

PROCÉDÉ DE MÉTALLISATION D'UN SUBSTRAT NON MÉTALLIQUE ET COMPOSITION DE PRÉTRAITEMENT

Publication

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Application

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Abstract (en)

[origin: WO2022043241A1] The present invention relates to a method for metallizing a non-metallic substrate, the method comprising the steps (A) to (C), wherein step (A) is a pre-treatment step for etching and step (C) the metallization step. In step (A) a pre-treatment composition is utilized comprising individual manganese (II), (III), and (IV) species. The present invention furthermore relates to a specific pre-treatment composition.

IPC 8 full level

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